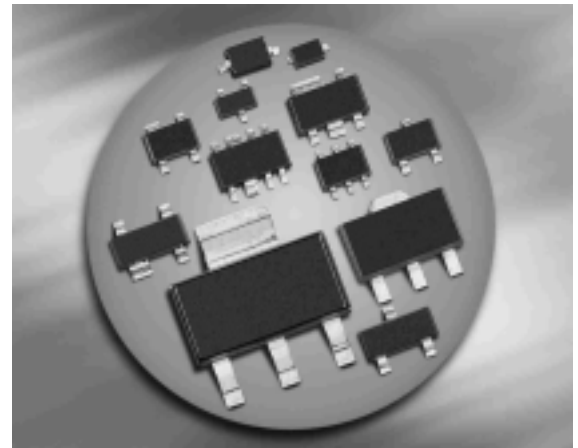
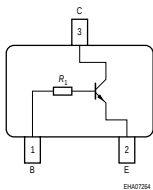


**NPN Silicon Digital Transistor**

- Switching circuit, inverter, interface circuit, driver circuit
- Built in bias resistor ( $R_1=22\text{ k}\Omega$ )


**BCR139F/L3**  
**BCR139T**


| Type     | Marking | Pin Configuration |     |     |   |   |   | Package  |
|----------|---------|-------------------|-----|-----|---|---|---|----------|
| BCR139F  | WYs     | 1=B               | 2=E | 3=C | - | - | - | TSFP-3   |
| BCR139L3 | WY      | 1=B               | 2=E | 3=C | - | - | - | TSFP-3-4 |
| BCR139T  | WY      | 1=B               | 2=E | 3=C | - | - | - | SC75     |

**Maximum Ratings**

| Parameter                              | Symbol       | Value       | Unit             |
|----------------------------------------|--------------|-------------|------------------|
| Collector-emitter voltage              | $V_{CEO}$    | 50          | V                |
| Collector-base voltage                 | $V_{CBO}$    | 50          |                  |
| Input forward voltage                  | $V_{i(fwd)}$ | 60          |                  |
| Input reverse voltage                  | $V_{i(rev)}$ | 5           |                  |
| Collector current                      | $I_C$        | 100         | mA               |
| Total power dissipation-               | $P_{tot}$    |             | mW               |
| BCR139F, $T_S \leq 128^\circ\text{C}$  |              | 250         |                  |
| BCR139L3, $T_S \leq 135^\circ\text{C}$ |              | 250         |                  |
| BCR139T, $T_S \leq 109^\circ\text{C}$  |              | 250         |                  |
| Junction temperature                   | $T_j$        | 150         | $^\circ\text{C}$ |
| Storage temperature                    | $T_{stg}$    | -65 ... 150 |                  |

**Thermal Resistance**

| Parameter                                | Symbol     | Value      | Unit |
|------------------------------------------|------------|------------|------|
| Junction - soldering point <sup>1)</sup> | $R_{thJS}$ |            | K/W  |
| BCR139F                                  |            | $\leq 90$  |      |
| BCR139L3                                 |            | $\leq 60$  |      |
| BCR139T                                  |            | $\leq 165$ |      |

**Electrical Characteristics at  $T_A = 25^\circ\text{C}$ , unless otherwise specified**

| Parameter | Symbol | Values |      |      | Unit |
|-----------|--------|--------|------|------|------|
|           |        | min.   | typ. | max. |      |

**DC Characteristics**

|                                                                                                      |               |     |    |     |            |
|------------------------------------------------------------------------------------------------------|---------------|-----|----|-----|------------|
| Collector-emitter breakdown voltage<br>$I_C = 100 \mu\text{A}$ , $I_B = 0$                           | $V_{(BR)CEO}$ | 50  | -  | -   | V          |
| Collector-base breakdown voltage<br>$I_C = 10 \mu\text{A}$ , $I_E = 0$                               | $V_{(BR)CBO}$ | 50  | -  | -   |            |
| Collector-base cutoff current<br>$V_{CB} = 40 \text{ V}$ , $I_E = 0$                                 | $I_{CBO}$     | -   | -  | 100 | nA         |
| Emitter-base cutoff current<br>$V_{EB} = 5 \text{ V}$ , $I_C = 0$                                    | $I_{EBO}$     | -   | -  | 100 | nA         |
| DC current gain <sup>2)</sup><br>$I_C = 5 \text{ mA}$ , $V_{CE} = 5 \text{ V}$                       | $h_{FE}$      | 120 | -  | 630 | -          |
| Collector-emitter saturation voltage <sup>2)</sup><br>$I_C = 10 \text{ mA}$ , $I_B = 0.5 \text{ mA}$ | $V_{CEsat}$   | -   | -  | 0.3 | V          |
| Input off voltage<br>$I_C = 100 \mu\text{A}$ , $V_{CE} = 5 \text{ V}$                                | $V_{i(off)}$  | 0.4 | -  | 0.8 |            |
| Input on voltage<br>$I_C = 2 \text{ mA}$ , $V_{CE} = 0.3 \text{ V}$                                  | $V_{i(on)}$   | 0.5 | -  | 1.1 |            |
| Input resistor                                                                                       | $R_1$         | 15  | 22 | 29  | k $\Omega$ |

**AC Characteristics**

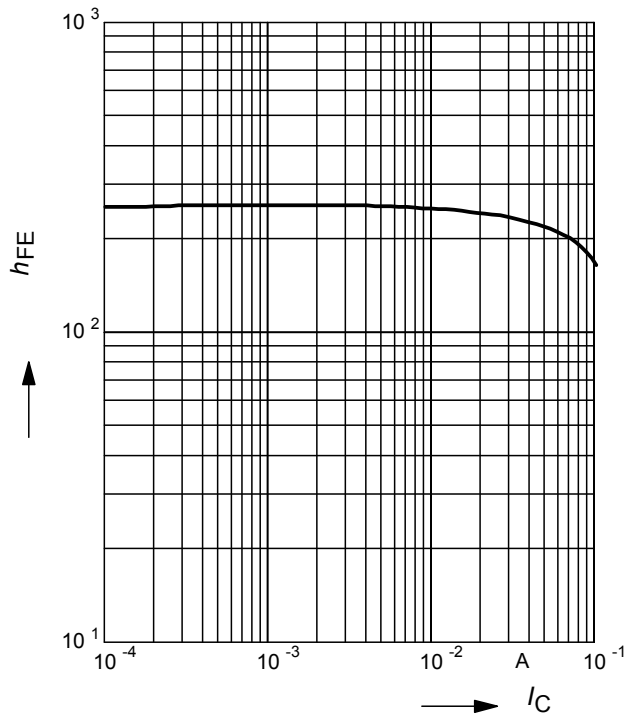
|                                                                                                |          |   |     |   |     |
|------------------------------------------------------------------------------------------------|----------|---|-----|---|-----|
| Transition frequency<br>$I_C = 10 \text{ mA}$ , $V_{CE} = 5 \text{ V}$ , $f = 100 \text{ MHz}$ | $f_T$    | - | 150 | - | MHz |
| Collector-base capacitance<br>$V_{CB} = 10 \text{ V}$ , $f = 1 \text{ MHz}$                    | $C_{cb}$ | - | 3   | - | pF  |

<sup>1)</sup>For calculation of  $R_{thJA}$  please refer to Application Note Thermal Resistance

<sup>2)</sup>Pulse test:  $t < 300 \mu\text{s}$ ;  $D < 2\%$

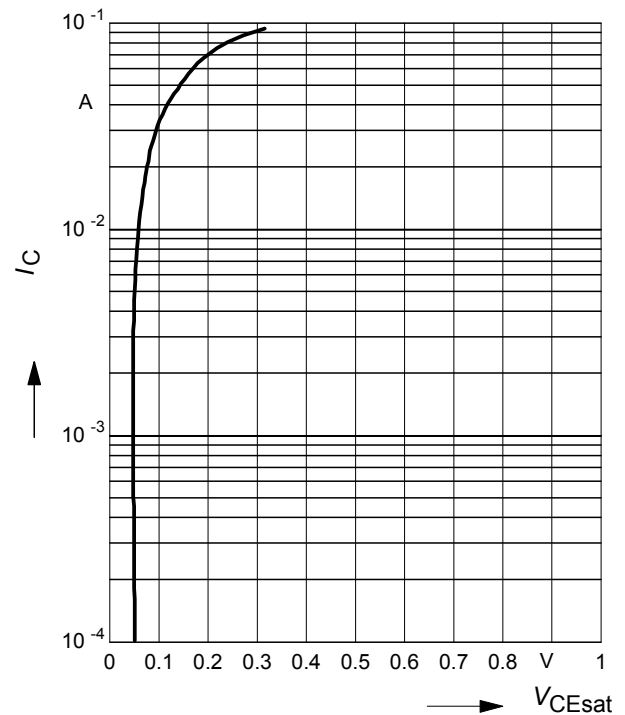
**DC current gain  $h_{FE} = f(I_C)$**

$V_{CE} = 5V$  (common emitter configuration)



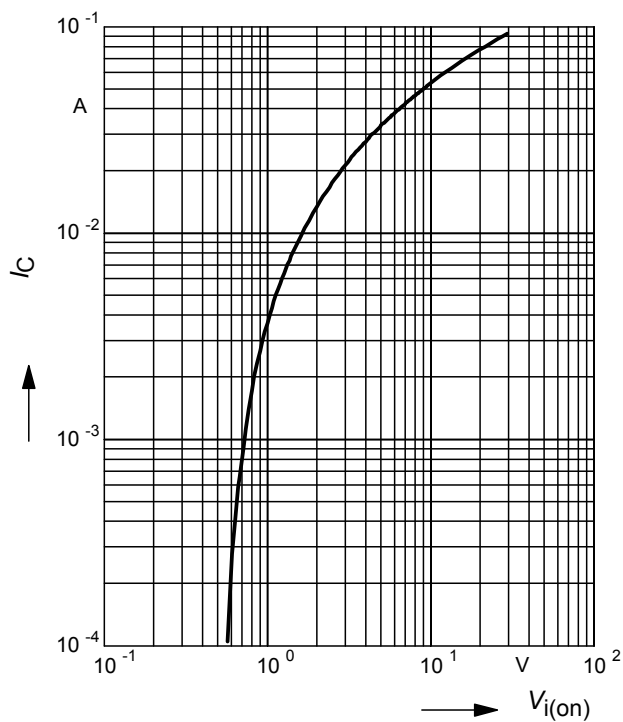
**Collector-emitter saturation voltage**

$V_{CEsat} = f(I_C)$ ,  $h_{FE} = 20$



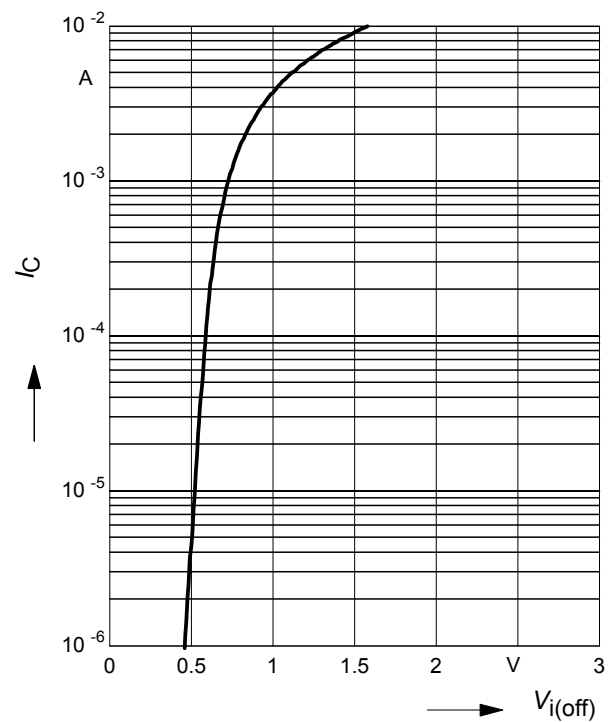
**Input on Voltage  $V_{i(on)} = f(I_C)$**

$V_{CE} = 0.3V$  (common emitter configuration)



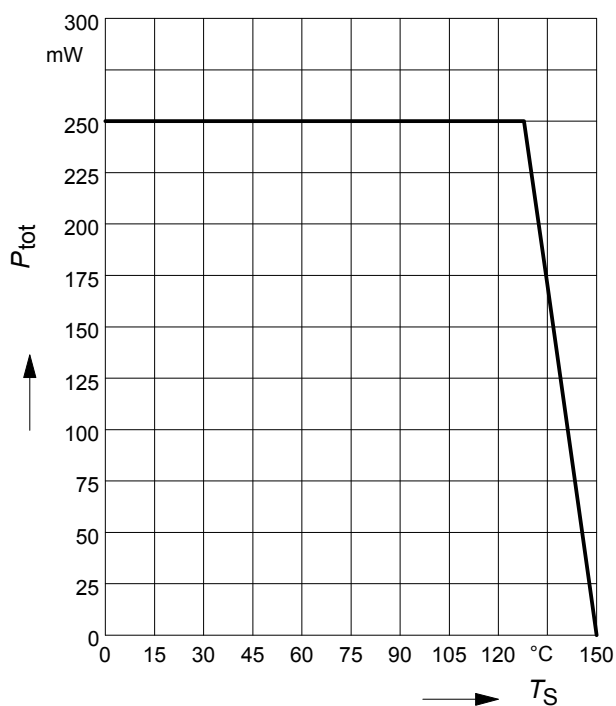
**Input off voltage  $V_{i(off)} = f(I_C)$**

$V_{CE} = 5V$  (common emitter configuration)



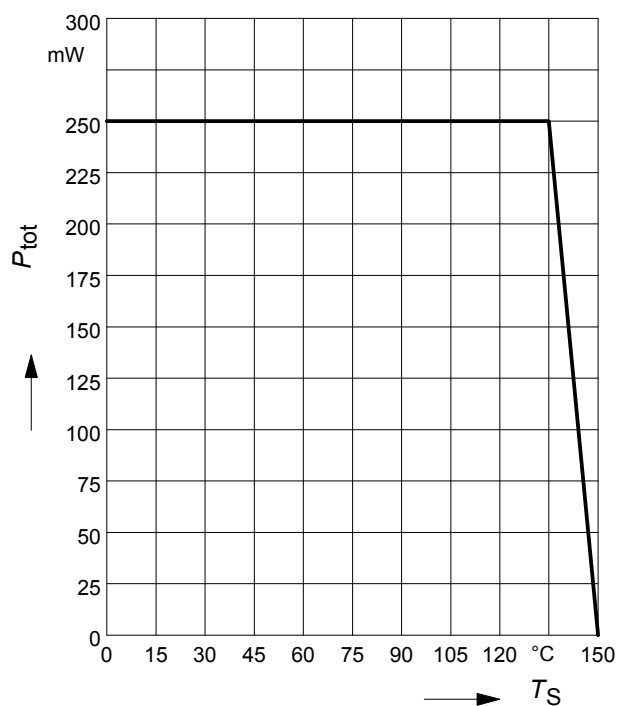
**Total power dissipation  $P_{\text{tot}} = f(T_S)$**

BCR139F



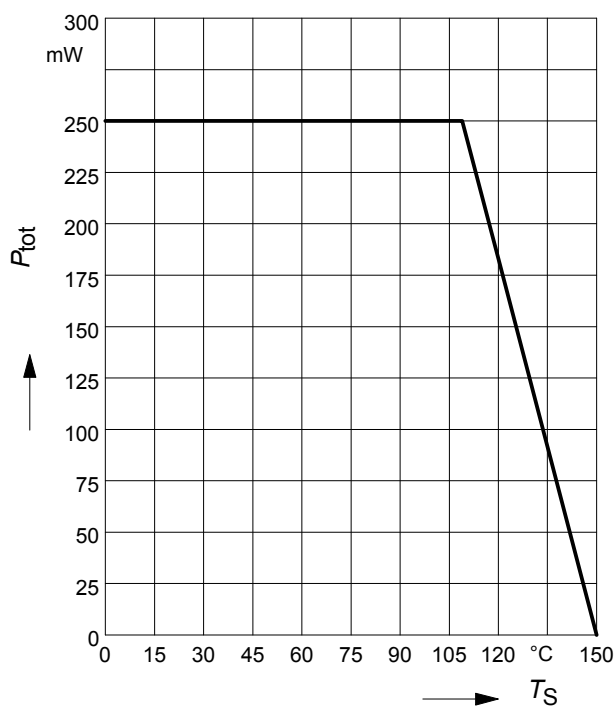
**Total power dissipation  $P_{\text{tot}} = f(T_S)$**

BCR139L3



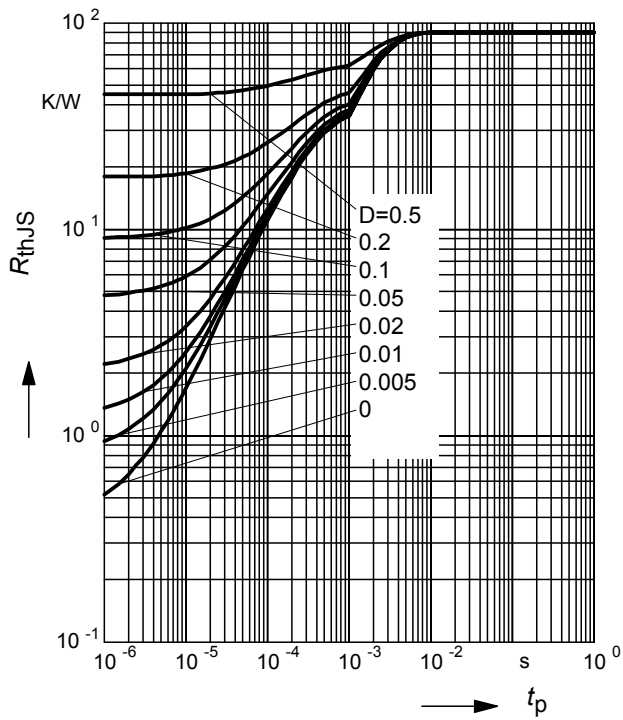
**Total power dissipation  $P_{\text{tot}} = f(T_S)$**

BCR139T



### Permissible Puls Load $R_{thJS} = f(t_p)$

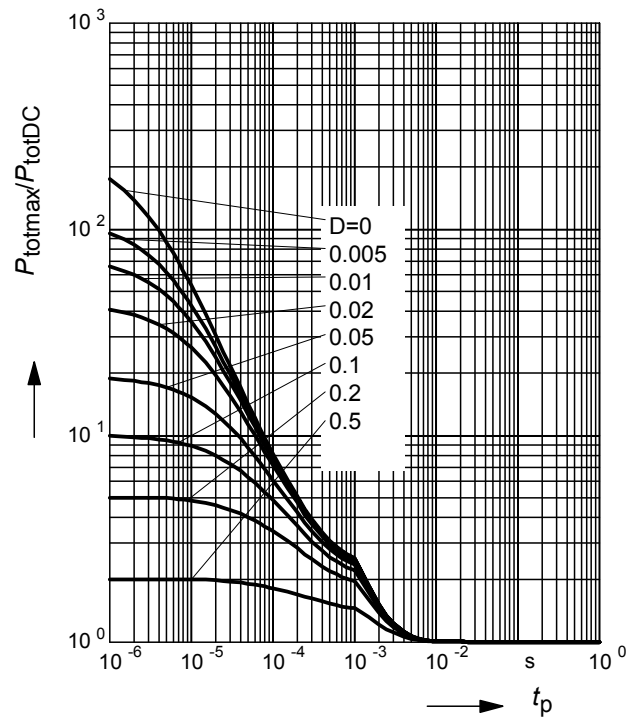
BCR139F



### Permissible Pulse Load

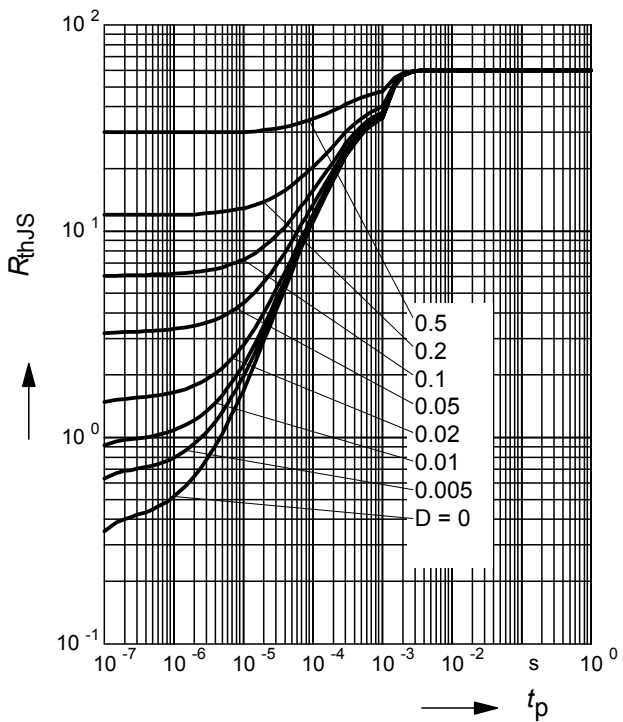
$$P_{totmax}/P_{totDC} = f(t_p)$$

BCR139F



### Permissible Puls Load $R_{thJS} = f(t_p)$

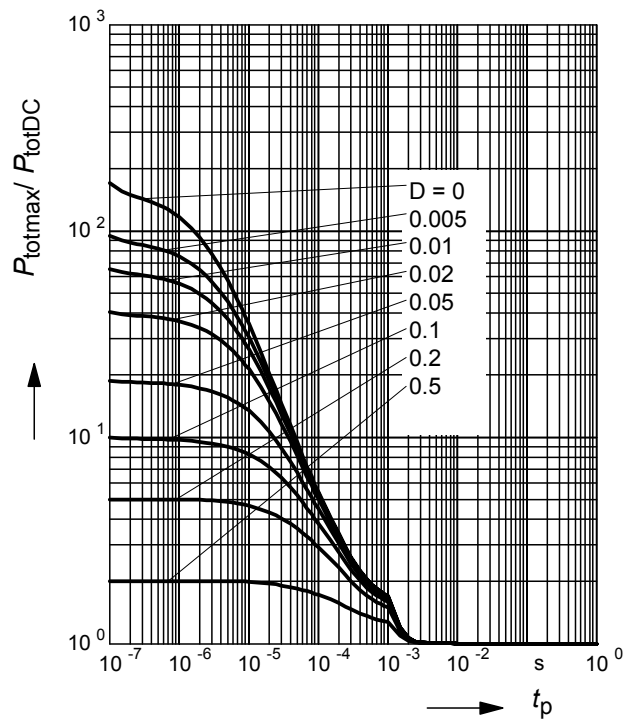
BCR139L3



### Permissible Pulse Load

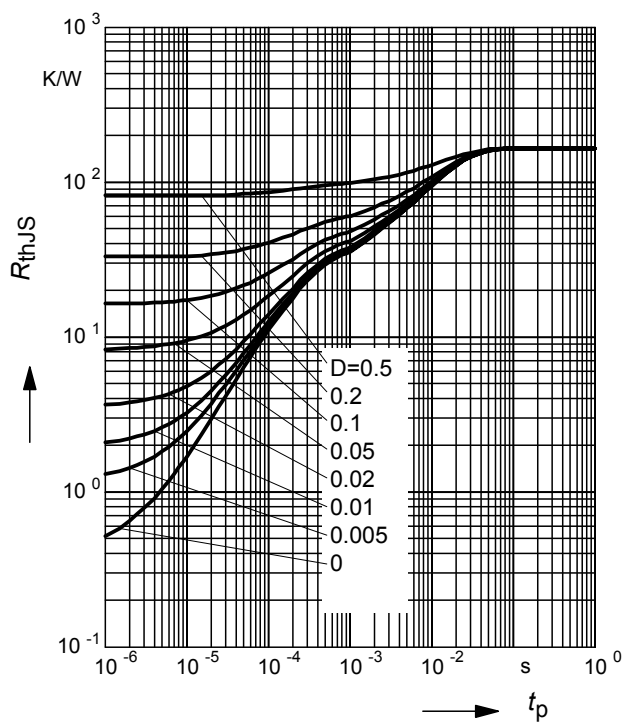
$$P_{totmax}/P_{totDC} = f(t_p)$$

BCR139L3



# Permissible Puls Load $R_{thJS} = f(t_p)$

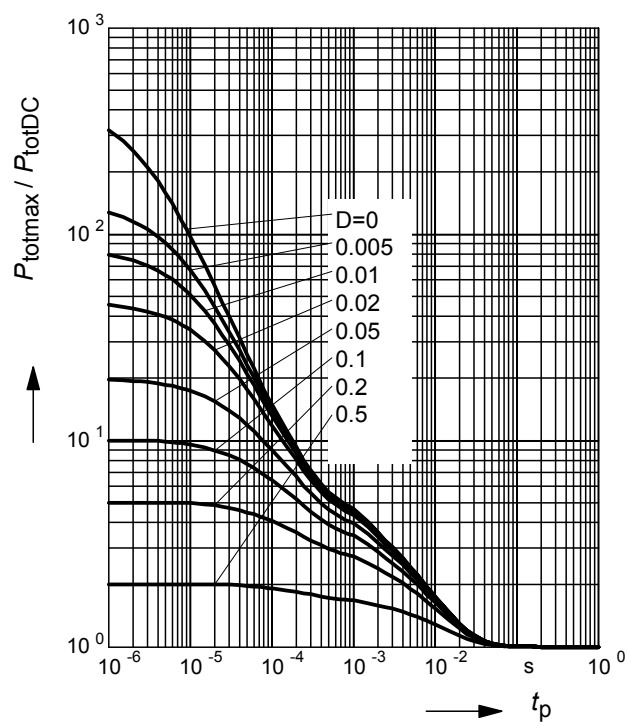
BCR139T



# Permissible Pulse Load

$$P_{totmax}/P_{totDC} = f(t_p)$$

BCR139T



The technical drawing shows two views of the M8000-1000 cable gland:

- Front View (Left):** Shows the main body with a total width of  $1.6 \pm 0.2$ . The distance between the mounting holes is  $0.2^{+0.1}_{-0.05}$ . The height of the main body is  $0.2^{+0.1}_{-0.05}$ . There are three mounting holes labeled 1, 2, and 3.
- Side View (Right):** Shows the profile of the gland. The total height is  $1.6 \pm 0.2$ . The top flange has a thickness of  $0.1 \text{ MAX.}$  and a width of  $0.7 \pm 0.1$ . The bottom flange has a thickness of  $0.15 \pm 0.1$ . The angle of the side flanges is  $10^\circ \text{ MAX.}$ .

Material specifications and tolerances are indicated by symbols like  $\oplus 0.10 \text{ (M)}$ ,  $\equiv 0.20 \text{ (M)}$ , and  $A$ .

Technical drawing of a mechanical part with dimensions:

- Overall width: 1.15
- Overall height: 0.65
- Top flange width: 0.4
- Top flange height: 0.65
- Bottom flange width: 0.4
- Bottom flange height: 0.65
- Central hole diameter: 0.5
- Distance from center to outer edge: 0.5

2005, December  
Date code

WHN

Pin 1

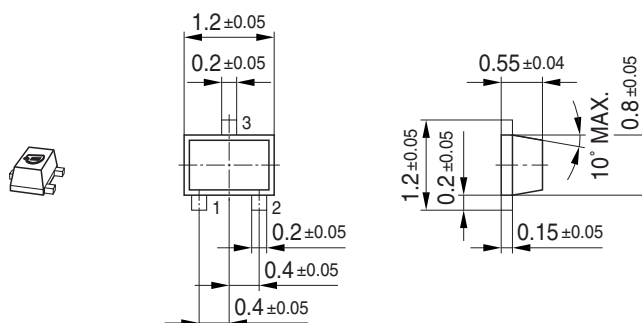
BCR108T  
Type code

Date Code marking for discrete packages with one digit (SCD80, SC79, SC75<sup>1)</sup>) CES-Code

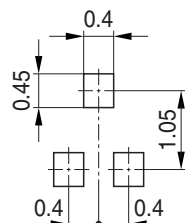
| Month | 2003 | 2004 | 2005 | 2006 | 2007 | 2008 | 2009 | 2010 | 2011 | 2012 | 2013 | 2014 |
|-------|------|------|------|------|------|------|------|------|------|------|------|------|
| 01    | a    | p    | A    | P    | a    | p    | A    | P    | a    | p    | A    | P    |
| 02    | b    | q    | B    | Q    | b    | q    | B    | Q    | b    | q    | B    | Q    |
| 03    | c    | r    | C    | R    | c    | r    | C    | R    | c    | r    | C    | R    |
| 04    | d    | s    | D    | S    | d    | s    | D    | S    | d    | s    | D    | S    |
| 05    | e    | t    | E    | T    | e    | t    | E    | T    | e    | t    | E    | T    |
| 06    | f    | u    | F    | U    | f    | u    | F    | U    | f    | u    | F    | U    |
| 07    | g    | v    | G    | V    | g    | v    | G    | V    | g    | v    | G    | V    |
| 08    | h    | x    | H    | X    | h    | x    | H    | X    | h    | x    | H    | X    |
| 09    | j    | y    | J    | Y    | j    | y    | J    | Y    | j    | y    | J    | Y    |
| 10    | k    | z    | K    | Z    | k    | z    | K    | Z    | k    | z    | K    | Z    |
| 11    | l    | 2    | L    | 4    | l    | 2    | L    | 4    | l    | 2    | L    | 4    |
| 12    | n    | 3    | N    | 5    | n    | 3    | N    | 5    | n    | 3    | N    | 5    |

1) New Marking Layout for SC75, implemented at October 2005.

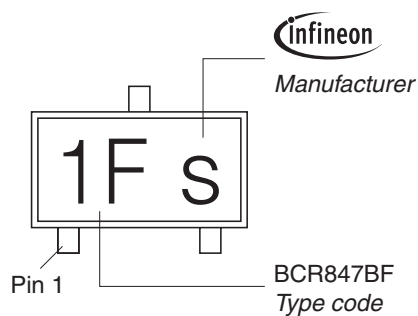
## Package Outline



## Foot Print

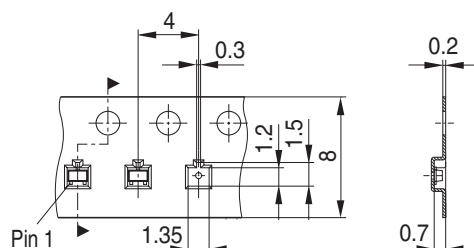


## Marking Layout (Example)

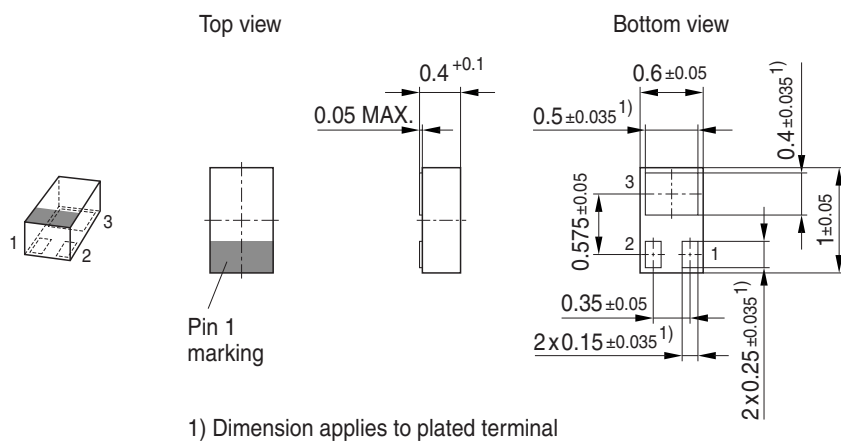


## Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel  
 Reel ø330 mm = 10.000 Pieces/Reel

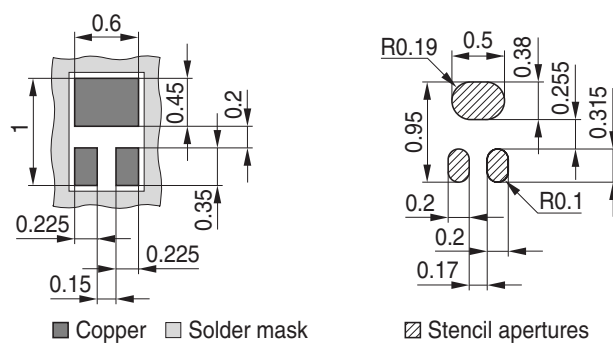


## Package Outline

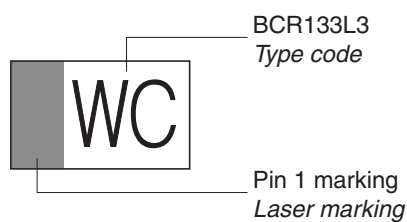


## Foot Print

For board assembly information please refer to Infineon website "Packages"

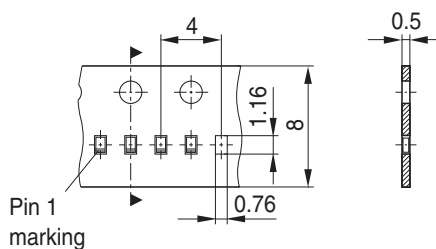


## Marking Layout



## Standard Packing

Reel ø180 mm = 15.000 Pieces/Reel



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